

NCE40P07S

NCE P-Channel Enhancement Mode Power MOSFET

Description

The NCE40P07S uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

V_{DS} =-40V,I_D =-6.2A

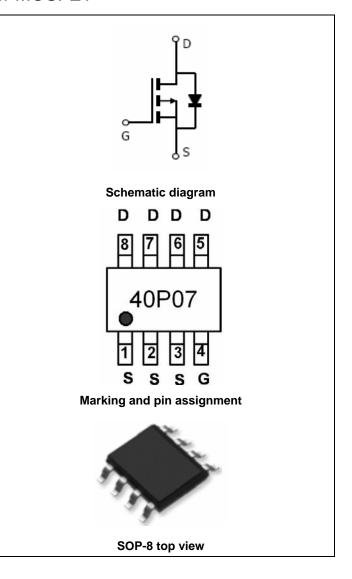
 $R_{DS(ON)}$ <25m Ω @ V_{GS} =-10V

 $R_{DS(ON)}$ <30m Ω @ V_{GS} =-4.5V

- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Excellent package for good heat dissipation

Application

- Power switching application
- Hard switched and high frequency circuits
- DC-DC converter



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
40P07	NCE40P07S	SOP-8	Ø330mm	12mm	2500 units

Absolute Maximum Ratings (T_A=25 ℃unless otherwise noted)

About Maximum Ratings (TA-20 Samoto Strict Wide Notice)					
Symbol	Limit	Unit			
V _{DS}	-40	V			
V _{GS}	±20	V			
I _D	-6.2	А			
I _D (100℃)	-4	Α			
I _{DM}	40	Α			
P _D	2.5	W			
T_{J} , T_{STG}	-55 To 150	$^{\circ}$ C			
	Symbol VDS VGS ID ID(100°C) IDM PD	Symbol Limit VDS -40 VGS ±20 ID -6.2 ID(100°C) -4 IDM 40 PD 2.5			



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NCE40P07S

Thermal Characteristic

Thermal Resistance ,Junction-to-Ambient ^(Note 2)	$R_{ heta JA}$	50	°C/W
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Electrical Characteristics (T_A=25 ℃ unless otherwise noted)

Parameter	Symbol	Condition	n Min		Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =-250μA -40		-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-40V,V _{GS} =0V -		-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =-250μA	-1.1	-1.7	-2.5	V
Drain-Source On-State Resistance	В	V _{GS} =-10V, I _D =-5A	-	16	25	mΩ
Diam-Source On-State Resistance	R _{DS(ON)}	V _{GS} =-4.5V, I _D =-5A	-	21	30	mΩ
Forward Transconductance	g FS	V_{DS} =-5 V , I_{D} =-5 A	20	-	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C _{lss}	\/ = 20\/\/ =0\/	-	1750	-	PF
Output Capacitance	C _{oss}	V_{DS} =-20V, V_{GS} =0V, F=1.0MHz	-	215	-	PF
Reverse Transfer Capacitance	C _{rss}	r-1.UIVIAZ	-	180	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t _{d(on)}		-	9	-	nS
Turn-on Rise Time	t _r	V_{DD} =-20V, , R_L =2 Ω	-	8	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =-10 V , R_{GEN} =3 Ω	-	28	-	nS
Turn-Off Fall Time	t _f		-	10	-	nS
Total Gate Charge	Qg	V - 20VI - FA	-	24	-	nC
Gate-Source Charge	Q _{gs}	V_{DS} =-20V, I_{D} =-5A,	-	3.5	-	nC
Gate-Drain Charge	Q_{gd}	V _{GS} =-10V	_	6	-	nC
Drain-Source Diode Characteristics			-			-
Diode Forward Voltage (Note 3)	V _{SD}	V_{GS} =0 V , I_{S} =-6 A	-	-	1.2	V
Diode Forward Current (Note 2)	I _S		-	-	-6.2	Α

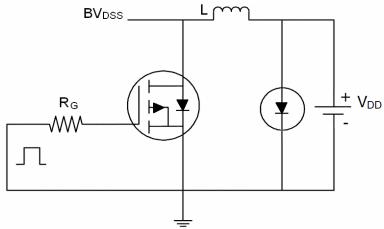
Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- **3.** Pulse Test: Pulse Width ≤ 300μ s, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production

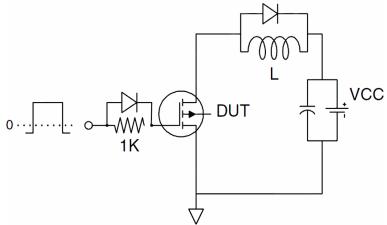


Test Circuit

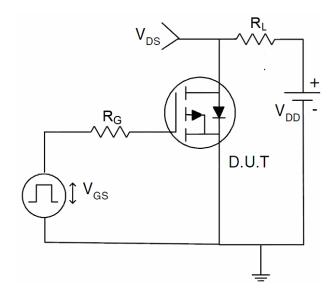
1) E_{AS} Test Circuit



2) Gate Charge Test Circuit



3) Switch Time Test Circuit





Typical Electrical and Thermal Characteristics (Curves)

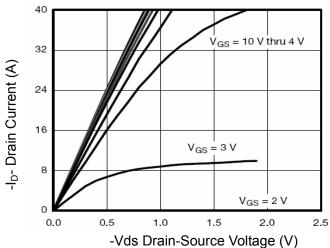


Figure 1 Output Characteristics

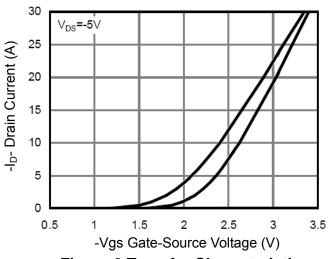


Figure 2 Transfer Characteristics

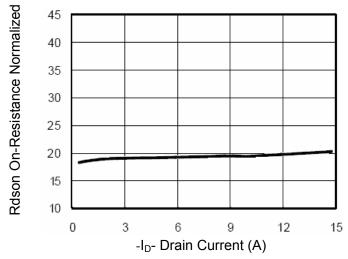


Figure 3 Rdson- Drain Current

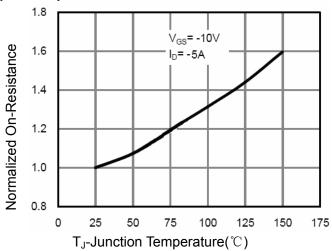


Figure 4 Rdson-Junction Temperature

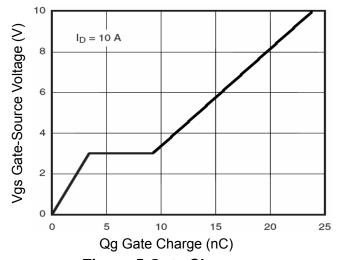


Figure 5 Gate Charge

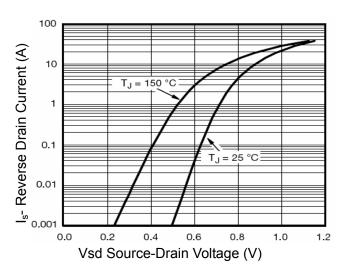


Figure 6 Source- Drain Diode Forward



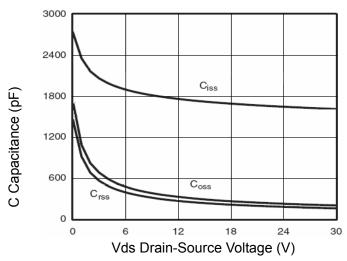


Figure 7 Capacitance vs Vds

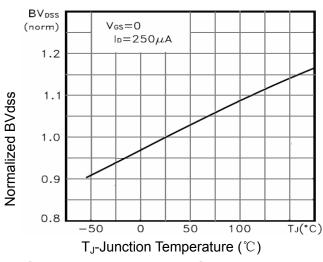


Figure 9 BV_{DSS} vs Junction Temperature

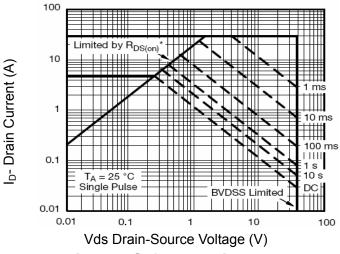


Figure 8 Safe Operation Area

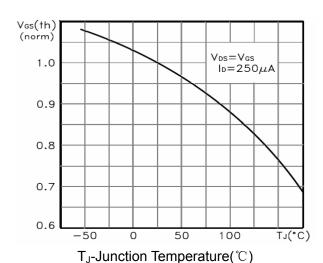


Figure 10 V_{GS(th)} vs Junction Temperature

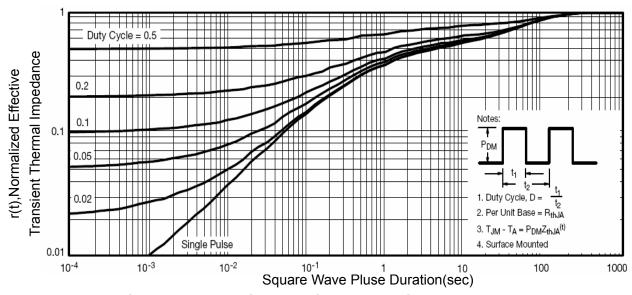
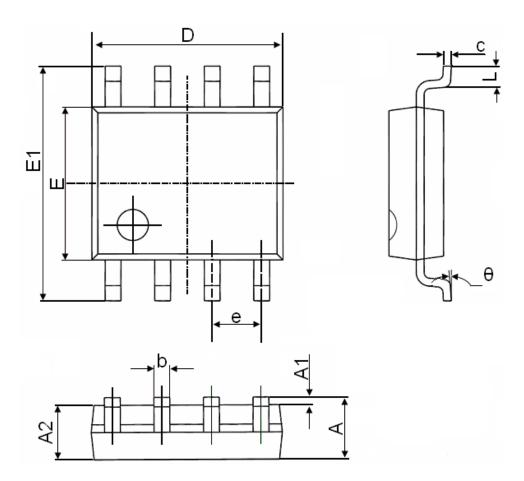


Figure 11 Normalized Maximum Transient Thermal Impedance

Pb Free Product



SOP-8 Package Information



Symbol	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
Α	1.350	1.750	0.053	0.069	
A1	0.100	0.250	0.004	0.010	
A2	1.350	1.550	0.053	0.061	
b	0.330	0.510	0.013	0.020	
С	0.170	0.250	0.006	0.010	
D	4.700	5.100	0.185	0.200	
E	3.800	4.000	0.150	0.157	
E1	5.800	6.200	0.228	0.244	
е	1.270(BSC)		0.050	(BSC)	
L	0.400	1.270	0.016	0.050	
θ	0°	8°	0°	8°	



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